

HT16512 1/4 to 1/11 Duty VFD Controller

Features

- Logic voltage: 3.0V~5.5V
- High-voltage output: V_{DD}-35V max.
- Multiple display (11-segment & 11-digit to 16-segment & 6-digit)
- 6×4 matrix key scanning
- 8 steps dimmer circuit
- · 4 LED output ports

- 4-bit general purpose input port
- No external resistors necessary for driver output (provides PMOS open-drain and pull-low resistor output)
- Serial interface with MCU (CLK, CS, DI, DO)
- 44-pin LQFP package

Applications

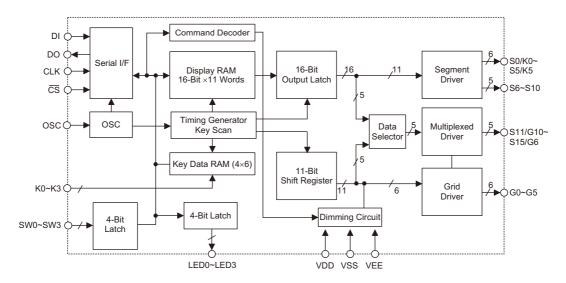
- Consumer products panel function control
- · Industrial measuring instrument panel function control
- Other similar application panel function control

General Description

HT16512 is a VFD (Vacuum Fluorescent Display) controller/driver that is driven on a 1/4 to 1/11 duty factor. It consists of 11 segment output lines, 6 grid output lines, 5 segment/grid output drive lines, 4 LED output ports, a control circuit, a display memory, and a key scan circuit.

Serial data inputs to the HT16512 through a three-line serial interface. This VFD controller/driver is ideal as a peripheral device for an MCU.

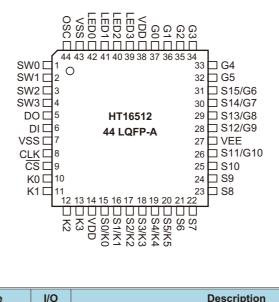
Block Diagram



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Pin Assignment



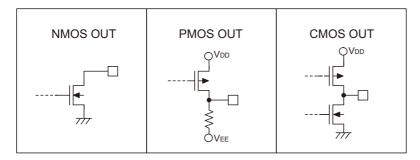
Pin Description

Pin No.	Pin Name	I/O	Description
1~4	SW0~SW3	I	4-bit general purpose input port Whether these pins are used or not, they should be connected to VDD or VSS.
5	DO	0	Output serial data at the falling edge of the shift clock, starting from low order bit. This is an NMOS open-drain output pin.
6	DI	1	Input serial data at the rising edge of the shift clock, starting from the low order bit.
7, 43	VSS	_	Negative power supply, ground Both of the VSS (pin 7 and pin 43) should be connected to ground.
8	CLK	I	Reads serial data at the rising edge, and outputs data at the falling edge.
9	CS	I	Initializes serial interface at the rising or falling edge of the HT16512. Then it waits to receive a command. Data input after \overline{CS} has fallen is processed as a command. While command data is processed, current processing is stopped, and the serial interface is initialized. While \overline{CS} is high, CLK is ignored.
10~13	K0~K3	I	Keying data input to these pins is latched at the end of the display cycle.
14, 38	VDD	_	Posistive power supply
15~20	S0/K0~S5/K5	0	Segment or key source output pins (dual function). This is PMOS open-drain and pull-low resistor output.
21~25	S6~S10	0	Segment driver output pins (segment only). This is PMOS open-drain and pull-low resistor output.
26, 28~31	S11/G10~S15/G6	0	Segment or Grid driver output pins. These pins are selectable for segment or grid driving. This is PMOS open-drain and pull-low resistor output.
27	VEE	_	VFD power supply
37~32	G0~G5	0	Grid driver output pins (Grid only). This is PMOS open-drain and pull-low resistor output.
42~39	LED0~LED3	0	LED driver output ports. This is a CMOS output pin.
44	OSC	I	Connected to an external resistor or an RC oscillator circuit.

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Approximate Internal Connections



Absolute Maximum Ratings

Supply VoltageV _{SS} -0.3V to V _{SS} +5.5V	Operating Temperature25°C to 75°C
Input VoltageV _{SS} -0.3V to V _{DD} +0.3V	Storage Temperature–50°C to 125°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

D.C. Characteristics Ta=25°C

Symbol	Downwoodow		Test Conditions	Min.	Тур.	Max.	Unit
Symbol	Parameter	V _{DD}	Conditions	WIII.			
V Lasis Const. Valles		3.3V		3.0	3.3	3.6	V
V _{DD}	Logic Supply Voltage	5.0V	_	4.5	5.0	5.5	V
V _{EE}	VFD Supply Voltage	_	_	0	_	V _{DD} -35	V
f	Oscillation Fraguency	3.3V	P -51k0	480	565	650	kHz
fosc	Oscillation Frequency	5.0V	R _{OSC} =51kΩ	465	545	630	kHz
D 0 1 1 D 11 D 11		3.3V	Driver output	50	100	150	1.0
R _{PL}	Output Pull-low Resistor	5.0V	Driver output	50	100	150	kΩ
	0	3.3V	No local MED disalone (f	_	_	3	mA
I _{DD}	Operating Current	5.0V	No load, VFD display off	_	_	5	mA
		3.3V	$\rm V_O = V_{DD} - 35V$, VFD driver off	_	_	-5	μА
I _{OL}	Driver Leakage Current	5.0V		_	_	-10	μА
	.== 0	3.3V	V =4V LED0. LED2	10	_	_	mA
I _{OL1}	LED Sink Current	5.0V	V _{OL} =1V, LED0~LED3	20	_	_	mA
		3.3V	V _{OH} =0.9V _{DD}	-0.5	_	_	mA
I _{OH1}	LED Source Current	5.0V	LED0~LED3	-1.0	_	_	mA
	Segment/Key Source Current	3.3V	V _{OH} =V _{DD} -2V S0/K0~S5/K5, S6~S10	-1.5	_	_	mA
I _{OH21}		5.0V		-3.0	_	_	mA
I _{OH22}		3.3V	V _{OH} =V _{DD} -2V G0~G5, S11/G10~S15/G6	-7.5	_	_	mA
	Segment/Grid Source Current	5.0V		-15.0	_		mA
	DO Sink Current	3.3V		2	_	_	mA
I _{OL3}		5.0V	V _{OL} =0.4V	4	_	_	mA

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Symbol	Parameter	Test Conditions		Min.	Turn	Max.	Unit
Symbol		V _{DD}	Conditions	IVIIII.	Тур.	IVIAX.	Ollit
V _{IH}	"H" Input Voltage	_	_	0.7V _{DD}	_	V_{DD}	V
V _{IL}	"L" Input Voltage	_	_	0	_	0.3V _{DD}	٧
V _{OH1}	High-level Output Voltage	3.3V	LED0~LED3, I _{OH1} =-0.5mA	- 0.9V _{DD}		V _{DD}	V
		5.0V	LED0~LED3, I _{OH1} =-1mA		_		
\/	Lave lavel Ordand Valtage	3.3V	LED0~LED3, I _{OL1} =10mA			4	.,
V _{OL1}	Low-level Output Voltage		LED0~LED3, I _{OL1} =20mA	0	_	ı	V
V _{OL2}	Low-level Output Voltage	3.3V	DO, I _{OL2} =2mA	0		0.4	\/
		5.0V	DO, I _{OL2} =4mA	0 -	0.4	V	

A.C. Characteristics Ta=25°C

Symbol	Parameter	Test Conditions			Time	May	Unit
Symbol	Parameter	V_{DD}	Conditions	Min.	Тур.	Max.	Ollit
t		3.3V		_	_	200	ns
t _{PHL}	Propagation Delay Time	5.0V	CLK→DO	_	_	100	ns
t _{PLH}	Propagation Delay Time	3.3V	$C_L=15pF, R_L=10k\Omega$		_	600	ns
PLH		5.0V		_	_	300	ns
t _{r1}		3.3V	C _L =300pF, S0~S10	_	_	4.0	μS
4r1	Rise Time	5.0V	ооорг, оо ото	_	_	2.0	μS
t _{r2}	Nise Time	3.3V	C _L =300pF, G0~G5, S11/G10~	_	_	1.0	μS
4r2		5.0V	S15/G6	_	_	0.5	μS
t _f	Fall Time	3.3V	C _L =300pF, Sn, Gn		_	240	μS
4	Fall Time		оц-эоорг , эп, оп	_	_	120	μS
f _{max}	Maximum Clock Frequency	3.3V	Duty=50%		_	0.5	MHz
'max		5.0V	Duty-50 76		_	1.0	MHz
C _i	Input Capacitance	3.3V	_		_	15	pF
Ci		5.0V			_	15	pF
t _{CW}	Clock Pulse Width	3.3V		800	_	_	ns
-CW	Clock Fulse Width	5.0V	_	400	_	_	ns
t _{sw}	Strobe Pulse Width	3.3V		2	_	_	μS
usw	Strobe Pulse Width	5.0V	_	1	_	_	μS
t _{su}	Data Setup Time	3.3V		200	_	_	ns
480		5.0V	_	100	_	_	ns
t.	Data Hold Time	3.3V		200	_	_	ns
t _h		5.0V	_	100	_	_	ns
t _{CS}	Clock-Strobe Time	3.3V	CLK rising adds to CS rising adds	2	_	_	μS
		5.0V	CLK rising edge to CS rising edge	1	_	_	μS
t	Wait Time	3.3V	CLK riging adds to CLK falling adds	2	_	_	μS
t _W		5.0V	CLK rising edge to CLK falling edge	1	_	_	μS



Functional Description

Display RAM and Display Mode

The static display RAM is organized into 22×8 bits and stores the data transmitted from an external device to the HT16512 through a serial interface. The contents of the RAM are directly mapped to the contents of the VFD driver. Data in the RAM can be accessed through the data setting, address setting and display control commands. It is assigned addresses in 8-bit unit as follows:

S8 ~ S11 S12 ~ S15	
01H	Digit0
03H	Digit1
05H	Digit2
07H	Digit3
09H	Digit4
0BH	Digit5
0DH	Digit6
0FH	Digit7
11H	Digit8
13H	Digit9
15H	Digit10
†	
b0 b1 b2 b3 b4 b5 b6 b7	
	01H 03H 05H 07H 09H 09H 0BH 0DH 0FH 11H 13H

Dimming Control

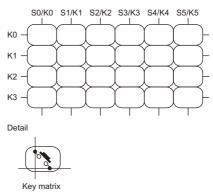
HT16512 provides 8-step dimmer function on display by controlling the 3-bit binary command code. The full pulse width of grid signal is divides into 16 uniform sections by PWM (pulse width modulation) technology.

The 16 uniform sections available form 8 steps dimmer via 3-bit binary code. The 8-step dimmer includes 1/16, 2/16, 4/16, 10/16, 11/16, 12/16, 13/16 and 14/16. The 1/16 pulse width indicates minimum lightness. The 14/16 pulse width represents maximum lightness. (Refer to the display control command).

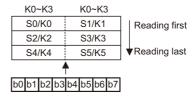
Key Matrix and Key-Input Data Storage RAM

The key matrix scans the series key states at each level of the key strobe signal (S0/K0~S5/K5) output of the HT16512. The key strobe signal outputs are time-multiplexed signals from S0/K0~S5/K5. The states of inputs K0~K3 are sampled by strobe signal S0/K0~S5/K5 and latched into the register.

The key matrix is made up of a 6×4 matrix, as shown below.



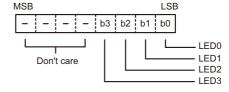
The data of each key is stored as illustrated below, and is read with the read command, starting from the least significant bit.



LED Port

The LED port belongs to the CMOS output configura-

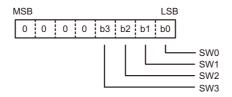
Data is written to the LED port with the write command, starting from the least port's least significant bit. In our application (see application circuits), the user adopts an internal NMOS device to a driver LED component by connecting VDD. When a bit of this port is 0, the corresponding LED lights; when the bit is 1, the LED turns off. The data of bits 5 through 8 are ignored.





SW Data

HT16512 provides an extra 4-bit general input port. The SW data is provided with available binary code. The SW data is read with the read command, starting from the least significant bit. Bits 5 through 8 of the SW data are 0



Commands

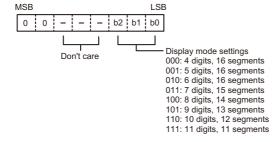
Commands set the display mode and status of the VFD driver.

The first 1 byte input to the HT16512 through the DI pin after the \overline{CS} pin has fallen, is regarded as a command. If \overline{CS} is set high while commands/data are transmitted, serial communication is initialized, and the commands/data being transmitted are not valid (however, the commands/data previously transmitted remains valid).

• Display mode setting commands

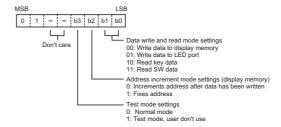
These commands initialize the HT16512 and select the number of segments and the number of grids (1/4~1/11 duty, 11 segments to 16 segments).

When these commands are executed, the display is forcibly turned off, and key scanning is also stopped. To resume display, the display command "ON" must be executed. If the same mode is selected, nothing happens.



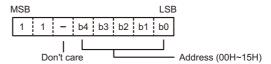
· Data setting commands

These commands set the data write and data read modes.



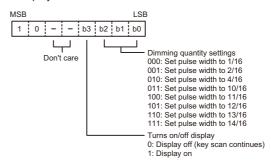
· Address setting commands

These commands set the address of the display memory.



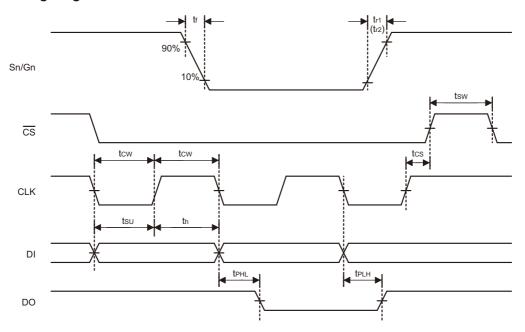
If address 16H or higher is set, data is ignored until a valid address is set.

· Display control commands

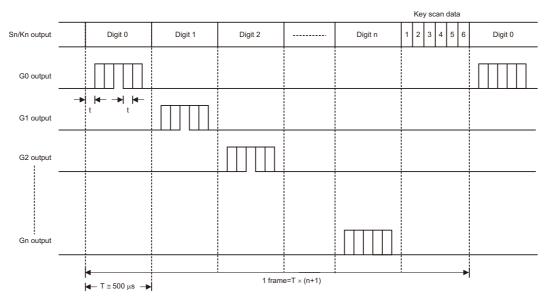




Timing Diagrams



Key Scanning and Display Timing



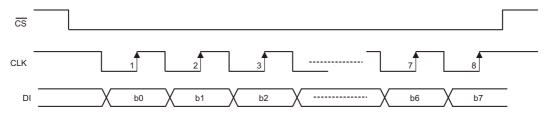
Note: n=0~5 t=1/16T

T: pulse width of segment signal is decided by oscillator frequency One cycle of key scanning consists of one frame.

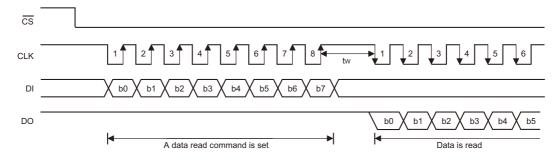


Serial Communication Format

• Reception (command/data write)



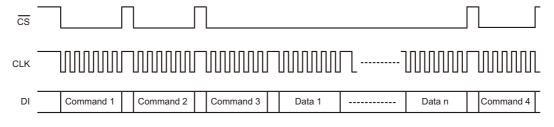
• Transmission (data read)



DO must be sure to connect an external pull-high resistor to this pin (1k Ω to 10k Ω).

Note: When data is read, a wait time "tw" of $1\mu s$ is necessary.

· Updating display memory by incrementing address



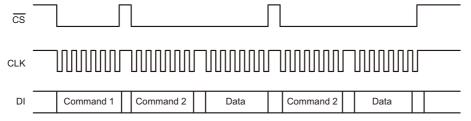
Command 1: sets display mode

Command 2: sets data Command 3: sets address

Data 1 to n: transfers display data (22 bytes max.)

Command 4: controls diplay

· Updating specific addresses

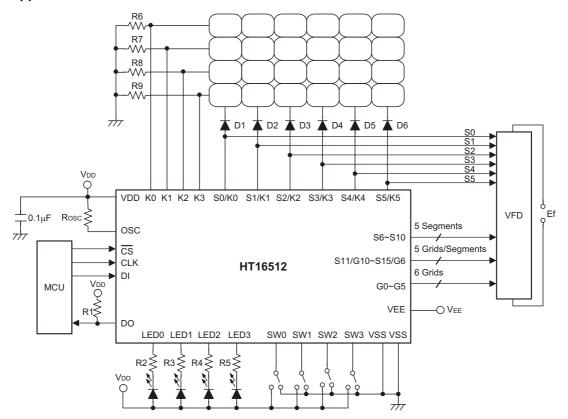


Command 1: sets data Command 2: sets address

Data: display data



Application Circuits



Note: R_{OSC} =51k Ω for oscillator resistor

R1=1~10k Ω for external pull-high resistor

R2~R5=750Ω~1.2kΩ

R6~R9=10k Ω for external pull-low resistor

D1~D6=1N4001

Ef=Filament voltage for VFD

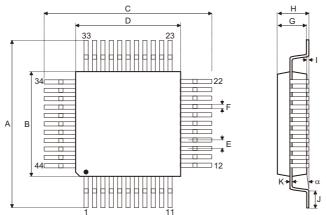
Both of the VSS (pin 7 and pin 43) should be connected to ground.



Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the Holtek website or the latest version of the package information.

44-pin LQFP (10mm×10mm) (FP2.0mm) Outline Dimensions



Comple al	Dimensions in inch						
Symbol	Min.	Nom.	Max.				
Α	0.469	_	0.476				
В	0.390	_	0.398				
С	0.469	_	0.476				
D	0.390	_	0.398				
E	_	0.031	_				
F	F —		_				
G	0.053	_	0.057				
Н	_	_	0.063				
I	_	0.004	_				
J	J 0.018		0.030				
K	0.004	_	0.008				
α	0°	_	7°				

Cymphal	Dimensions in mm						
Symbol	Min.	Nom.	Max.				
Α	11.90	_	12.10				
В	9.90	_	10.10				
С	11.90	_	12.10				
D	9.90	_	10.10				
E	_	0.80	_				
F	F —		_				
G	1.35	_	1.45				
Н	_	_	1.60				
I	_	0.10	_				
J	0.45	_	0.75				
K	0.10	_	0.20				
α	0°	_	7°				

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